

Title (en)

OXYGEN-FREE COPPER ALLOY AND METHOD FOR ITS MANUFACTURE AND USE OF COPPER ALLOY

Title (de)

SAUERSTOFFFREIE KUPFERLEGIERUNG UND HERSTELLUNGSVERFAHREN DAFÜR UND VERWENDUNG VON KUPFERLEGIERUNG

Title (fr)

ALLIAGE DE CUIVRE EXEMPT D'OXYGENE ET SON PROCEDE DE FABRICATION ET L'UTILISATION DE L'ALLIAGE EN CUIVRE

Publication

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Application

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Abstract (en)

[origin: WO2004087976A1] The invention relates to an oxygen-free copper alloy containing magnesium between 30 - 180 ppm, preferably 50 - 150 ppm in order to improve temperature resistance. The invention also relates to a method for the manufacture of the copper alloy and to the use of the copper alloy.

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IPC 8 full level

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